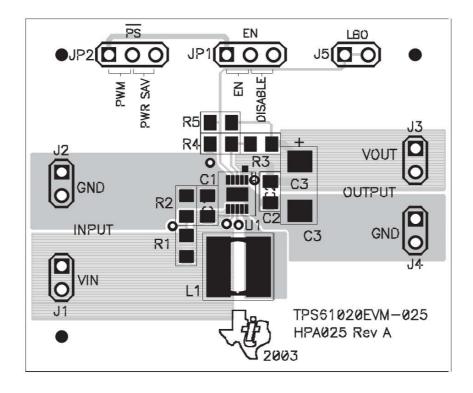
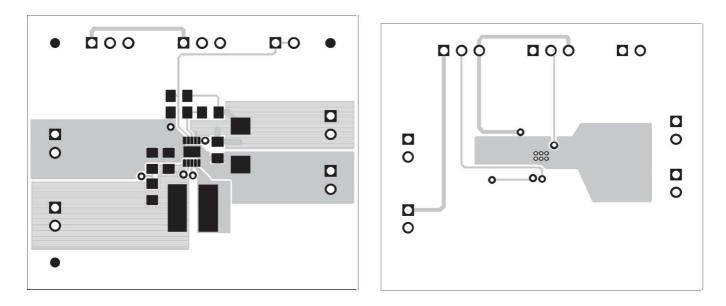
## PMP30003 Rev.A

## Assembly



## **Top & Bottom Layer**



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